Case Docket No.: 00P9119 US

Date: December <sup>28</sup>, 2000

12/28/00

ASSISTANT COMMISSIONER FOR PATENTS Washington, D.C. 20231
Box PATENT APPLICATION

Sir:

Transmitted herewith for filing is the patent application of:

Inventor:

Lian, et al.

For: MULTI-LAYER Pt ELECTRODE FOR DRAM AND FRAM WITH HIGH K DIELECTRIC MATERIALS

This application includes:

16 pages: specification, claims and abstract6 sheets of drawings, \_\_ formal/\_X informal

\_\_ photographs

Also enclosed is:

Declaration and Power of Attorney
Information Disclosure Statement pursuant to 37 CFR 1.56.

The filing fee has been calculated as shown below:

FOR:	(Col. 1) NO. FILED	(Col. 2) NO. EXTRA RATE	OTHER THAN A SMALL ENTITY FEE	
BASIC FEE	XXXXXXXX	XXXXXXXX	XXXXX	\$710
TOTAL CLAIMS	20 =	0	x 18=	\$0
INDEP CLAIMS	3 =	0	x 80=	\$0
* MULTIPLE DEPENDENT CLAIM PRESENTED			+260.=	\$0
			TOTAL	\$710

Y Please charge my Deposit Account No. 19-2179 in the amount of \$710.00. A duplicate copy of this sheet is enclosed.

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X Any additional filing fees required under 37 CFR 1.16.

X Any patent application processing fees under 37 CFR 1.17.

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X Any patent application processing fees under 37 CFR 1.17.

X Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Stanton C. Braden Registration No. 32,556

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